

N- and P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY						
	V _{DS} (V)	$R_{DS(on)}$ (m Ω) (Typ.)	I _D (A) ^a	Q _g (Typ.)		
N-Channel	30	14 at V _{GS} = 10 V	25	10.7 nC		
		20 at V GS = 4.5 V	23	10.7 110		
P-Channel	- 30	15.5 at VGS = - 10 V	- 28	22 nC		
	- 30	20 at V GS = - 4.5 V	- 28	22 110		

FEATURES

- DT-Trench Power MOSFET
- 100 % R_g and UIS tested
- Excellent Thermal Performance

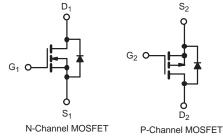


APPLICATIONS

- Motor Drive
- DC-FAN

DFN5X6-8L-Dual Pin Configuration





ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER		SYMBOL	N-Channel	P-Channel	UNIT	
Drain-Source Voltage	V_{DS}	30	- 30	V		
Gate-Source Voltage		V_{GS}	± 20	± 20	V	
Continuous Drain Current (T _{.I} = 150° C) ^a	T _C = 25 °C	I_	25	- 28	<u> </u>	
Continuous Diam Curient (1) = 130 °C)-	T _C = 100 °C	l _D	17	- 20	Α	
Pulsed Drain Current ^b	I _{DM}	100	- 112			
Maximum Power Dissipation ^C	T _C = 25 °C	D	22	28	W	
Maximum Fower Dissipation 5	T _C = 100 °C	P _D	8.8	11.2	VV	
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	-55 to +150		°C		

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THERMAL RESISTANCE RATINGS							
Parameter	Symbol	N-Channel	P-Channel	Unit			
raiametei	Symbol		Max	Oilit			
Maximum Junction-to-Ambient ^d	R_{thJA}	45	50	°C/W			
Maximum Junction-to-Case (Drain)	R_{thJC}	5.68	4.46	C/VV			

Notes

- a. Calculated continuous current based on maximum allowablejunction temperature.
- b. Repetitive rating; pulse width limited by max. junction temperature.
- c. Pd is based on max. junction temperature, using junction-case thermal resistance.
- d. The value of R_{BJA} is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper,in a still air environment with Ta=25 °C.

N-Channel Electrical Characteristics (T _C = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS		TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V_{DS} $V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		30	-	-	V	
Gate Threshold Voltage	V _{GS(th)}	$V_{GS(th)}$ $V_{DS} = V_{GS}$, $I_D = 250 \mu A$		-	3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zero Gate Voltage Drain Current	lane	$V_{DS} = 30 V, V_{GS} = 0 V$	-	-	1	1 100 µA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$	-	-	100		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	25	-	-	Α	
Drain Source On State Registence 8	В	V _{GS} = 10 V, I _D = 10 A	-	14	17	mΩ	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 8 A	-	20	25		
Forward Transconductance ^a	g _{fs}	V _{DS} = 5 V, I _D = 10 A	-	15	-	S	
Dynamic ^b				•			
Input Capacitance	C _{iss}		-	462	-	pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 15 \text{ V}, f = 1 \text{ MHz}$	-	68	-		
Reverse Transfer Capacitance	C _{rss}		-	59	-		
Total Gate Charge ^c	Q_g		-	10.7	-		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	0.8	-	nC	
Gate-Drain Charge ^c	Q_{gd}		-	2.2	-		
Gate Resistance	Rg	f = 1 MHz	-	3.8	-	Ω	
Turn-On Delay Time ^c	t _{d(on)}		-	5.5	-		
Rise Time ^c	t _r	$V_{DD} = 15 \text{ V}, I_D = 10 \text{ A}, R_g = 3 \Omega$	-	12	-	20	
Turn-Off Delay Time ^c	t _{d(off)}	V _{GS} = 10 V	-	16	-	ns -	
Fall Time ^c	t _f		-	8	-		
Drain-Source Body Diode Ratings and Characteristics ^b (T _C = 25 °C)							
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C	-	-	25	Α	
Pulsed Current	I _{SM}		-	-	100	Α	
Forward Voltage ^a	V_{SD}	I _F = 1 A, V _{GS} = 0 V	-	-	1.2	V	
Reverse Recovery Time	t _{rr}	I _F = 10 A, di/dt = 100 A/μs	-	50	-	ns	
Reverse Recovery Charge	Q_{rr}			42	-	nC	

Notes

- a. Pulse test; pulse width $\leq 400~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those in dicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended pe riods may affect device reliability.



PARAMETER	SYMBOL	MBOL TEST CONDITIONS		TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}			-	-		
Gate Threshold Voltage	V _{GS(th)}			-	- 3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zoro Coto Voltogo Droin Current	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V	-	-	- 1 - 100 μA		
Zero Gate Voltage Drain Current		V _{DS} = -24V, V _{GS} = 0 V, T _J = 55 °C	-	-			
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≥– 5 V, V _{GS} = - 10 V	- 28	-	-	Α	
Drain-Source On-State Resistance a	D	V _{GS} = - 10 V, I _D = - 10 A	-	15.5	19	mΩ	
Diani-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 5 A	-	20	25		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 5 V, I _D = - 10 A	-	31	-	S	
Dynamic ^b							
Input Capacitance	C _{iss}		-	1440	-	pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = -15 \text{ V}, f = 1 \text{ MHz}$	-	165	-		
Reverse Transfer Capacitance	C _{rss}		-	155	-		
Total Gate Charge ^c	Q_g		-	22	-	nC	
Gate-Source Charge ^c	Q _{gs}	V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 10 A	-	2.5	-		
Gate-Drain Charge ^c	Q_{gd}		-	6	-		
Gate Resistance	R _g	f = 1 MHz	-	7	-	Ω	
Turn-On Delay Time ^c	t _{d(on)}		-	9.5	-		
Rise Time ^c	t _r	$V_{DD} = -15 \text{ V}, R_{q} = 3 \Omega,$	-	31	-		
Turn-Off Delay Time ^c	t _{d(off)}	In = - 10 A , Vgs = - 10 V	-	35	-	ns	
Fall Time ^c	t _f		-	10	-		
Drain-Source Body Diode Ratings and Characteristics ^b (T _C = 25 °C)							
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C	-	-	- 28	Α	
Pulsed Current	I _{SM}		-	-	- 112	Α	
Forward Voltage ^a	V_{SD}	I _F = - 1 A, V _{GS} = 0 V	-	-	-1.2	V	
Reverse Recovery Time	$I_{\rm F} = -10 \text{A}, \text{di/dt} = 100 \text{A/µs}$		-	11	-	ns	
Reverse Recovery Charge			-	12	-	nC	

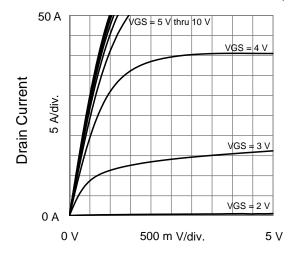
Notes

- a. Pulse test; pulse width \leq 400 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not su bject to production testing.
- c. Independent of operating temperature.

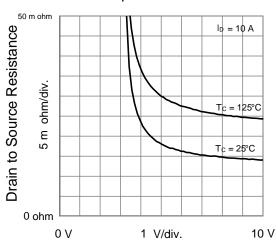
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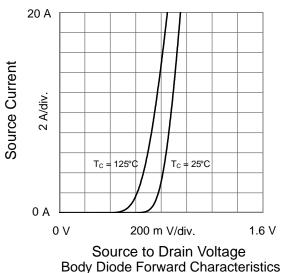
N-CHANNEL TYPICAL CHARACTERISTICS (25°C, unless otherwise noted)

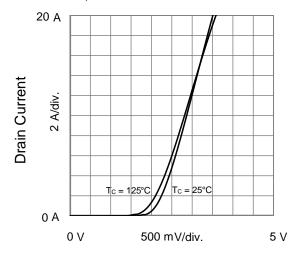


Drain to Source Voltage **Output Characteristics**

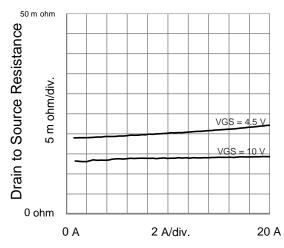


Gate to Source Voltage Drain to Source Resistance vs. Gate to Source Voltage

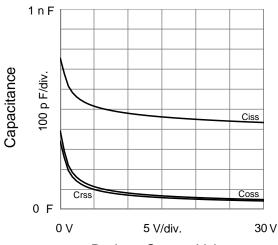




Gate to Source Voltage Transfer Characteristics



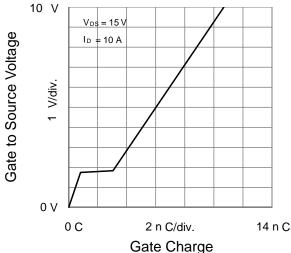
Drain Current



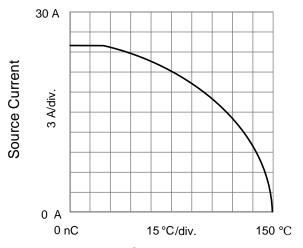
Drain to Source Voltage Capacitances



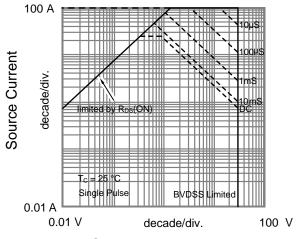
N-CHANNEL TYPICAL CHARACTERISTICS (25°C, unless otherwise noted)



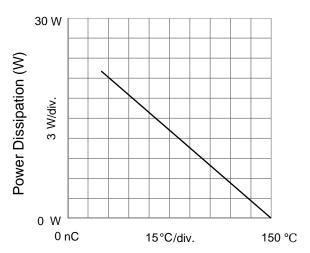
Gate to Source Voltage vs. GateCharge



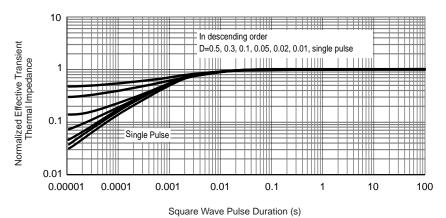
T_C - Case Temperature



Source to Drain Voltage Safe Operating Area, Junction-to-Case



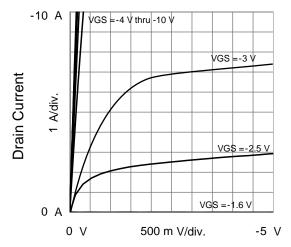
T_C - Case Temperature



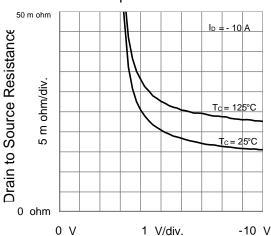
Normalized Thermal Transient Impedance, Junction-to-Case

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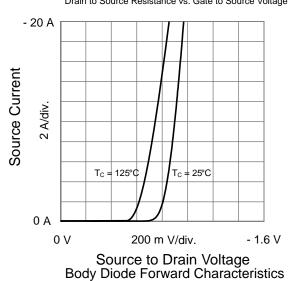
P-CHANNEL TYPICAL CHARACTERISTICS (25°C, unless otherwise noted)

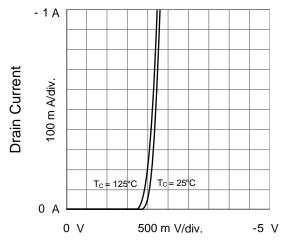


Drain to Source Voltage Output Characteristics

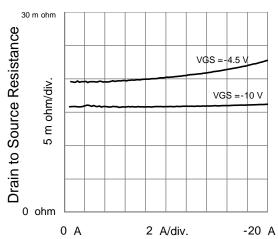


Gate to Source Voltage
Drain to Source Resistance vs. Gate to Source Voltage

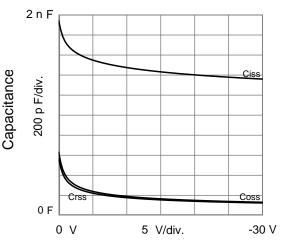




Gate to Source Voltage Transfer Characteristics



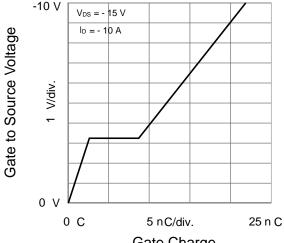
Drain Current
Drain to Source Resistance vs. Drain Current



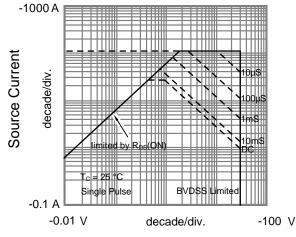


N-CHANNEL TYPICAL CHARACTERISTICS (25°C, unless otherwise noted)

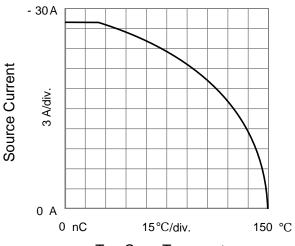




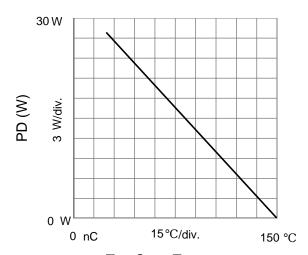




Source to Drain Voltage Safe Operating Area, Junction-to-Ambient

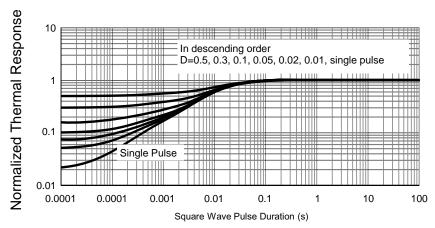


 $T_{C} \textbf{ - Case Temperature}_{\text{Current Derating}}$



T_C - Case Temperature

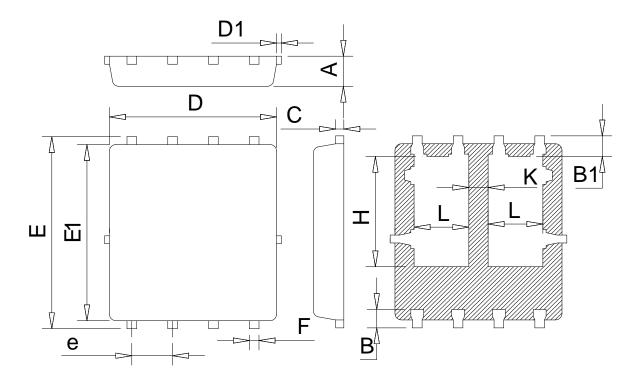
Power Derating



Normalized Thermal Transient Impedance

DFN5X6-8L-D PACKAGE OUTLINE

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COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

Symbol	Min	Тур	Max
А	0.85	0.95	1.05
В	0.46	0.58	0.73
B1	0.52	0.65	0.78
С	0.18	0.254	0.32
D	4.70	5.20	5.50
D1	-	-	0.18
E	5.75	6.05	6.35
E1	5.35	5.65	5.85
е	1.20	1.27	1.50
F	0.20	0.40	0.50
Н	3.20	3.47	3.80
L	1.35	1.70	2.10
K	0.35	0.60	1.00





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